# MOSFET – Power, N-Channel, SUPERFET<sup>®</sup> III 800 V, 600 mΩ, 8 A

# NTPF600N80S3Z

## **Description**

800 V SUPERFET III MOSFET is ON Semiconductor's high performance MOSFET family offering 800 V breakdown voltage.

New 800 V SUPERFET III MOSFET which is optimized for primary switch of flyback converter, enables lower switching losses and case temperature without sacrificing EMI performance thanks to its optimized design. In addition, internal Zener Diode significantly improves ESD capability.

This new family of 800 V SUPERFET III MOSFET enables to make more efficient, compact, cooler and more robust applications because of its remarkable performance in switching power applications such as Laptop adapter, Audio, Lighting, ATX power and industrial power supplies.

#### **Features**

- Typ.  $R_{DS(on)} = 550 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 15.5 nC)
- Low Stored Energy in Output Capacitance (Eoss = 1.74 μJ @ 400 V)
- 100% Avalanche Tested
- ESD Improved Capability with Zener Diode
- RoHS Compliant

#### **Applications**

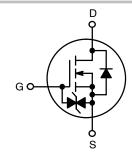
- Adapters / Chargers
- LED Lighting
- AUX Power
- Audio
- Industrial Power



## ON Semiconductor®

## www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
800 V	600 m $Ω$	8 A	

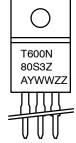


**POWER MOSFET** 



TO-220F CASE 221D

## **MARKING DIAGRAM**



T600N80S3Z = Specific Device Code A = Assembly Location

Y = Year WW = Work Week ZZ = Lot Code

### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

## **ABSOLUTE MAXIMUM RATINGS** ( $T_J = 25^{\circ}C$ , unless otherwise noted)

Symbol	Paramo	Value	Unit	
$V_{DSS}$	Drain-to-Source Voltage	-Source Voltage		V
$V_{GS}$	Gate-to-Source Voltage	DC	±20	V
		AC (f > 1 Hz)	±30	
I <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	8*	Α
		Continuous (T <sub>C</sub> = 100°C)	5*	
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)		Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2	2)	24	mJ
I <sub>AS</sub>	Avalanche Current (Note 2)		1.2	А
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		0.28	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		10	
$P_{D}$	Power Dissipation (T <sub>C</sub> = 25°C)		28	W
		Derate Above 25°C	0.23	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
$T_L$	Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from Case for 10 seconds)		260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse–width limited by maximum junction temperature.

2.  $I_{AS} = 1.2 \text{ A}$ ,  $R_{G} = 25 \Omega$ , starting  $T_{J} = 25^{\circ}\text{C}$ .

3.  $I_{SD} \le 2 \text{ A}$ , di/dt  $\le 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \le 400 \text{ V}$ , starting  $T_{J} = 25^{\circ}\text{C}$ .

## THERMAL RESISTANCE RATINGS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Junction-to-Case - Steady State	4.4	°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State	62.5	

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packaging Method	Reel Size	Tape Width	Quantity
NTPF600N80S3Z	NTPF600N80S3Z	TO-220F	Tube	N/A	N/A	50 Units

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	TERISTICS				-	
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 \text{ V, } I_D = 1 \text{ mA, } T_J = 25^{\circ}\text{C}$	800			V
		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	900			V
$\Delta BV_{DSS}/\Delta T_{J}$	Drain-to-Source Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 1 mA, Referenced to 25°C		1.1		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V			1	μΑ
		V <sub>DS</sub> = 640 V, T <sub>C</sub> = 125°C		0.8		1
I <sub>GSS</sub>	Gate-to-Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			1	μΑ
ON CHARACTI	ERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 0.18 \text{ mA}$	2.2		3.8	V
R <sub>DS(on)</sub>	Static Drain-to-Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4 A		550	600	mΩ
9FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 4 A		9.4		S
DYNAMIC CHA	RACTERISTICS				-	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 250 kHz		725		pF
C <sub>oss</sub>	Output Capacitance			12		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V		139		pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V		21		pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 4 A, V <sub>GS</sub> = 10 V		15.5		nC
$Q_{gs}$	Gate-to-Source Gate Charge	(Note 4)		3.1		nC
$Q_{gd}$	Gate-to-Drain "Miller" Charge			5.1		nC
ESR	Equivalent Series Resistance	f = 1 MHz		3.5		Ω
SWITCHING CI	HARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_D = 4 \text{ A}, V_{GS} = 10 \text{ V},$		12.3		ns
t <sub>r</sub>	Turn-On Rise Time	$R_g = 4.7 \Omega$ (Note 4)		5.9		ns
t <sub>d(off)</sub>	Turn-Off Delay Time			39.5		ns
t <sub>f</sub>	Turn-Off Fall Time			8.2		ns
SOURCE-TO-I	DRAIN DIODE CHARACTERISTICS				•	•
I <sub>S</sub>	Maximum Continuous Source-to-Drain Diode Forward Current				8	Α
I <sub>SM</sub>	Maximum Pulsed Source-to-Drain Diode Forward Current				21	Α
V <sub>SD</sub>	Source-to-Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 4 A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 2 A,		137		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> /dt = 100 A/μs		0.91		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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<sup>4.</sup> Essentially independent of operating temperature typical characteristics.

## **TYPICAL CHARACTERISTICS**

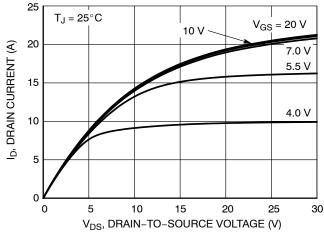


Figure 1. On-Region Characteristics

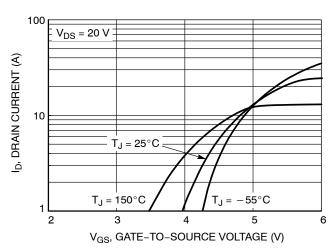


Figure 2. Transfer Characteristics

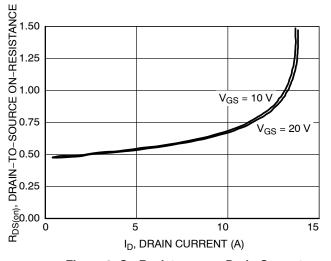


Figure 3. On Resistance vs. Drain Current

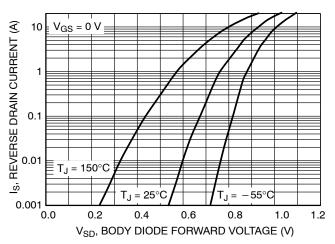


Figure 4. Diode Forward Voltage vs. Current

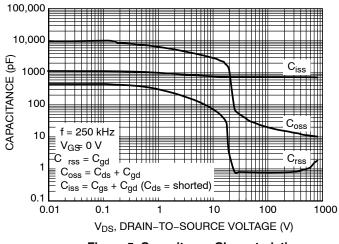


Figure 5. Capacitance Characteristics

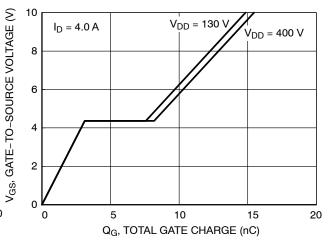


Figure 6. Gate Charge Characteristics

## **TYPICAL CHARACTERISTICS**

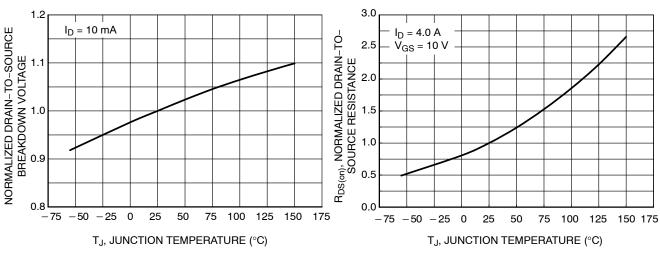


Figure 7. Normalized BV<sub>DSS</sub> vs. Temperature

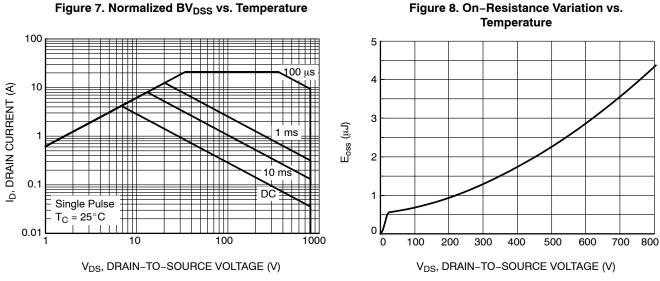


Figure 9. Safe Operating Area

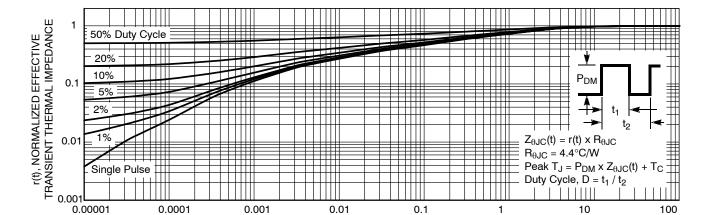


Figure 10. E<sub>oss</sub> vs. Drain-to-Source Voltage

t<sub>1</sub>, RECTANGULAR PULSE DURATION (sec)

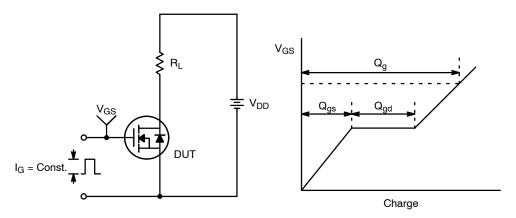


Figure 12. Gate Charge Test Circuit & Waveform

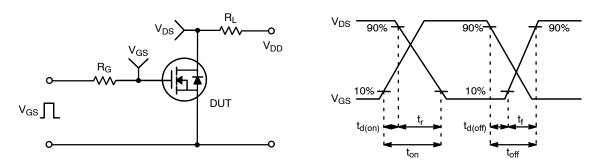


Figure 13. Resistive Switching Test Circuit & Waveforms

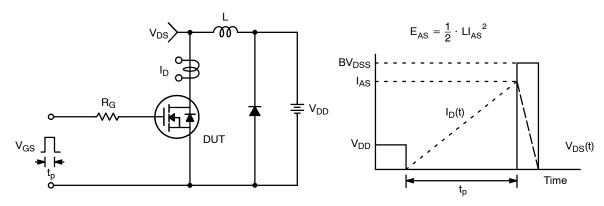


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

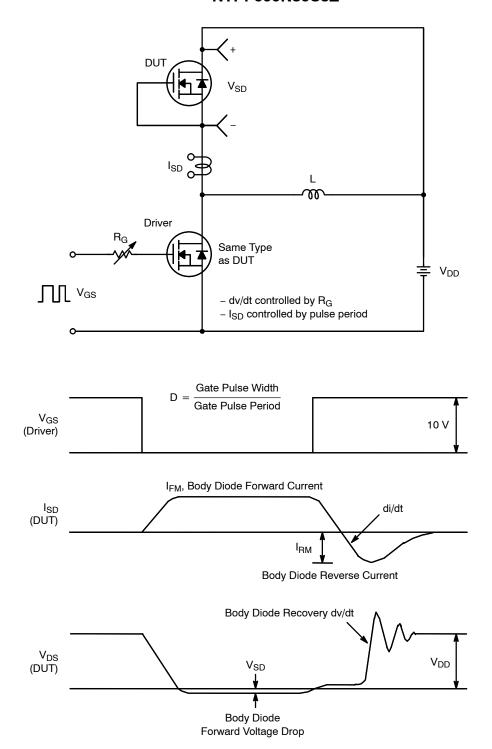


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

# **MECHANICAL CASE OUTLINE**





SCALE 1:1

3. CATHODE

## TO-220 FULLPAK CASE 221D-03 ISSUE K

**DATE 27 FEB 2009** 

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**AYWW** 

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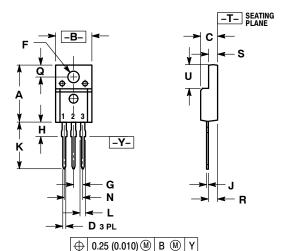
**AKA** 

Rectifier

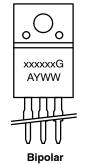
- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH
- 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03.

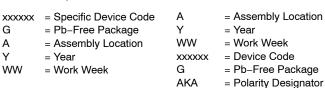
	INCHES		MILLIN	IETERS		
DIM	MIN	MAX	MIN	MAX		
Α	0.617	0.635	15.67	16.12		
В	0.392	0.419	9.96	10.63		
C	0.177	0.193	4.50	4.90		
D	0.024	0.039	0.60	1.00		
F	0.116	0.129	2.95	3.28		
G	0.100	BSC	2.54	BSC		
Н	0.118	0.135	3.00	3.43		
J	0.018	0.025	0.45	0.63		
K	0.503	0.541	12.78	13.73		
L	0.048	0.058	1.23	1.47		
N	0.200	0.200 BSC		BSC		
Q	0.122	0.138	3.10	3.50		
R	0.099	0.117	2.51	2.96		
S	0.092	0.113	2.34	2.87		
U	0.239	0.271	6.06	6.88		

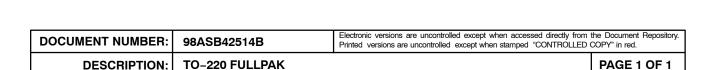
## **MARKING DIAGRAMS**



STYLE 1: PIN 1. GATE STYLE 2: PIN 1. BASE STYLE 3: PIN 1. ANODE 2. COLLECTOR 3. EMITTER 2. DRAIN 2. 2. CATHODE 3. ANODE 3. SOURCE STYLE 6: PIN 1. MT 1 2. MT 2 3. GATE STYLE 4: PIN 1. CATHODE STYLE 5: PIN 1. CATHODE 2. ANODE 3. GATE ANODE







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